

## 1. Package summary

Terminal position code D (double)

Package type descriptive code XSON3

Package type industry code XSON3

Package style descriptive code XSON (extremely thin small outline; no leads)

Package style suffix code NA (not applicable)

Package body material type P (plastic)

Mounting method type S (surface mount)

**Issue date** 11-7-2013

#### **Table 1. Package summary**

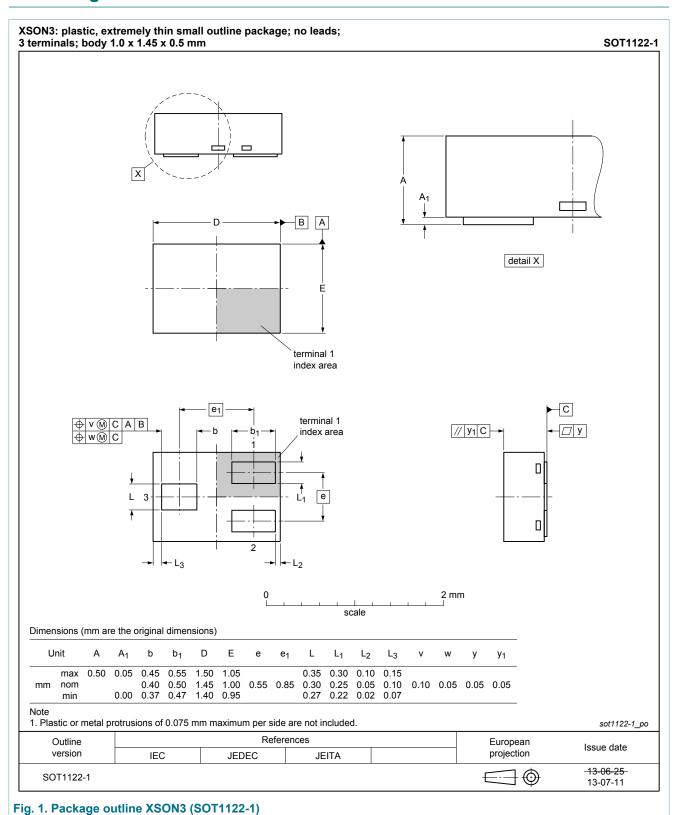
Symbol	Parameter	Min	Тур	Nom	Max	Unit
D	package length	1.4	-	1.45	1.5	mm
E	package width	0.95	-	1	1.05	mm
Α	seated height	[tbd]	-	[tbd]	0.5	mm
е	nominal pitch	-	-	0.55	-	mm
n <sub>2</sub>	actual quantity of termination	-	-	3	-	



NXP Semiconductors SOT1122-1

plastic extremely thin small outline package; no leads; 3 terminals

# 2. Package outline



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plastic extremely thin small outline package; no leads; 3 terminals

### 3. Legal information

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